

Title (en)

IRRADIATION STRATEGY IN ADDITIVE MANUFACTURING WITH PULSED IRRADIATION

Title (de)

BESTRAHLUNGSSTRATEGIE IN DER ADDITIVEN HERSTELLUNG MIT GEPUHLSTER BESTRAHLUNG

Title (fr)

STRATÉGIE D'ÉMISSION EN FABRICATION ADDITIVE À ÉMISSION PULSÉE

Publication

**EP 4225523 A1 20230816 (DE)**

Application

**EP 21824486 A 20211124**

Priority

- EP 20216448 A 20201222
- EP 2021082833 W 20211124

Abstract (en)

[origin: WO2022135817A1] The invention relates to a method for powder-bed-based additive manufacturing of a component (10), comprising setting irradiation vectors (V<sub>h</sub>, V<sub>c</sub>) for a layer (L) to be irradiated for the component (10), wherein: irradiation vectors (V<sub>h</sub>, V<sub>c</sub>) are irradiated below a length of 1 mm in a pulsed irradiation operation (pw); and a pulse frequency below 3 kHz and a scan speed below 250 mm/a are selected. The invention also relates to a correspondingly manufactured component, to an associated method for providing manufacturing instructions, and to an associated computer program product.

IPC 8 full level

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C-Set (source: EP)

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DOCDB simple family (publication)

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